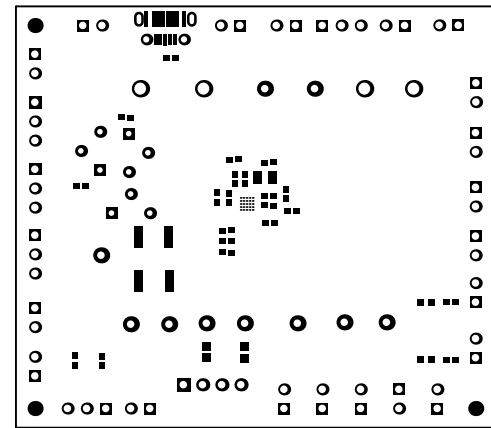
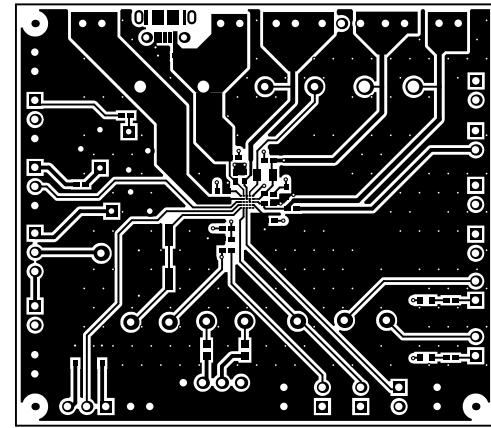


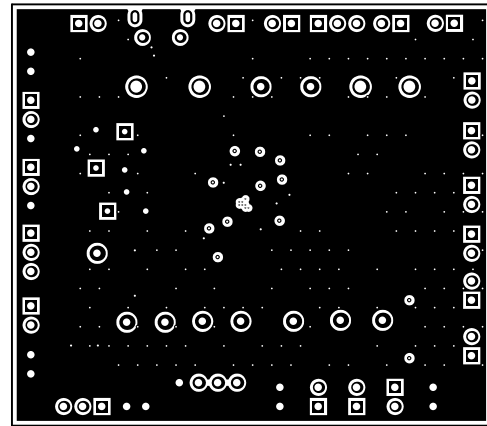
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: .TID		
PLOT NAME = Top Overlay	GENERATED : 8/4/2015	10:53:38 AM	TEXAS INSTRUMENTS



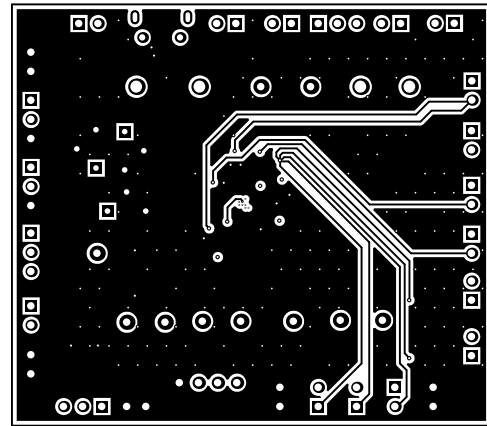
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: .TID		
PLOT NAME = Top Solder Mask	GENERATED : 8/4/2015	10:53:42 AM	TEXAS INSTRUMENTS



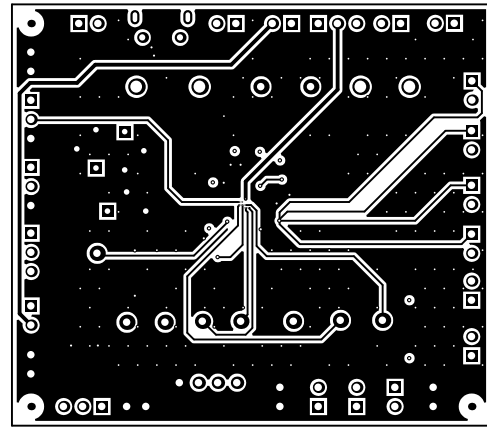
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: .TID		
PLOT NAME = Top Layer	GENERATED : 8/4/2015	10:53:46 AM	TEXAS INSTRUMENTS



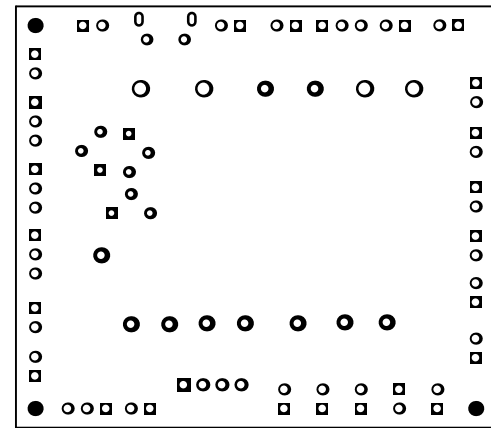
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 1	TID #: .TID		
PLOT NAME = MidLayer1	GENERATED : 8/4/2015 10:53:51 AM	TEXAS INSTRUMENTS	



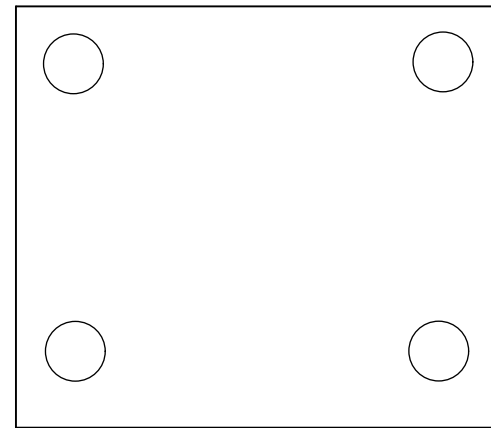
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 2	TID #: .TID		
PLOT NAME = MidLayer2	GENERATED : 8/4/2015 10:53:55 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: .TID		
PLOT NAME = Bottom Layer	GENERATED : 8/4/2015 10:53:59 AM	TEXAS INSTRUMENTS	

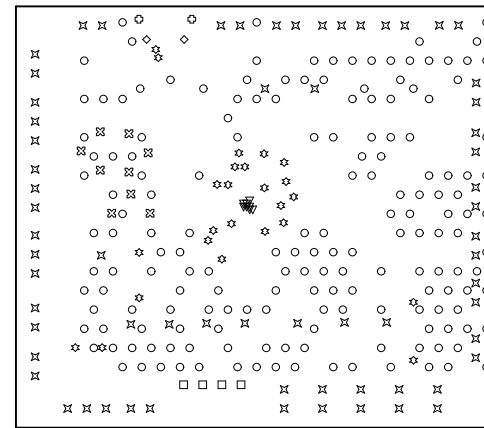


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: .TID		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/4/2015 10:54:03 AM	TEXAS INSTRUMENTS	



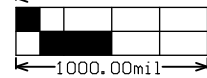
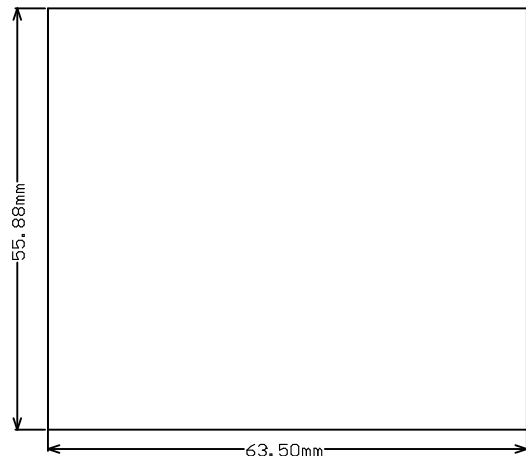
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: .TID		
PLOT NAME = Bottom Overlay	GENERATED : 8/4/2015 10:54:09 AM	TEXAS INSTRUMENTS	

All 6mil vias are to be filled and plated shut



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
□	8	6.00mil (0.152mm)	PTH	Round
☆	167	10.00mil (0.254mm)	PTH	Round
▽	25	12.00mil (0.305mm)	PTH	Round
○	9	29.53mil (0.750mm)	PTH	Round
▽	2	33.46mil (0.850mm)	PTH	Round
⊗	65	40.00mil (1.016mm)	PTH	Round
⊕	4	40.16mil (1.020mm)	PTH	Round
◇	4	63.00mil (1.600mm)	PTH	Round
▣	2	23.62mil (0.600mm)	PTH	Slot
	286 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: .TID		
PLOT NAME = Drill Drawing	GENERATED : 8/4/2015	10:54:13 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR731	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: .TID		
PLOT NAME = Board Dimensions	GENERATED : 8/4/2015 10:54:18 AM	TEXAS INSTRUMENTS	

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